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Avoiding chromium transport from stainless steel interconnects into contact layers and oxygen electrodes in intermediate temperature solid oxide electrolysis stacks



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HIGHLIGHTS

- Study on transport of Cr from stainless steel interconnects in solid oxide electrolysis anodes.
- Influence of porous LSMC and LNF contact coatings.
- Combination of microstructural and chemical analyses.
- Degradation in perovskite contact coatings on interconnects after 3000 h at 700 °C in O₂.
- Introduction of a dense (Co,Mn)₃O₄ coating necessary.

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ABSTRACT

We investigated the ability of $(La_{0.8}Sr_{0.2})(Mn_{0.5}Co_{0.5})O_{3-\delta}$ (LSMC) and $La(Ni_{0.6}Fe_{0.4})O_{3-\delta}$ (LNF) contact coatings to avoid the transport of Cr from steel interconnects to solid oxide electrolysis electrodes, especially to the anode. The transport of chromium from commercial Crofer 22 APU (ThyssenKrupp) and K41X (AISI441, Aperam Isbergues) steels through LSMC and LNF contact coatings into adjacent $(La_{0.8}Sr_{0.2})$ $MnO_{3-\delta}$ (LSM) oxygen electrodes was investigated in an oxygen atmosphere at 700 °C. Chromium concentrations of up to 4 atom% were detected in the contact coatings after thermal treatments for 3000 h, which also lead to the presence of chromium in adjacent LSM electrodes. Introduction of a dense $(Co,Mn)_3O_4$ coating between steel and contact coating was necessary to prevent the diffusion of chromium into contact coatings and electrodes and should lead to extended stack performance and lifetime.

1. Introduction

Based on their electrical conductivity, thermal expansion behavior, mechanical properties (formability, ease of fabrication, creep resistance) and low cost, ferritic stainless steels are suitable materials for interconnects in solid oxide fuel or electrolysis cells (SOFC, SOEC) operating at intermediate temperatures (600 °C–800 °C). Besides distributing and separating the process gases on anode and cathode sides, interconnects are used for electrically connecting several cells in

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series in planar SOFC or SOEC stacks. As a consequence, their performance is influenced by surface properties, which are governed by the oxidation layers or scales which intrinsically form on ferritic stainless steels. In terms of surface stability and electrical conductivity, the commercial ferritic Fe—Cr—Mn alloys Crofer 22 APU (22 wt% Cr, ThyssenKrupp) and K41X (AISI441, 18 wt% Cr, Aperam Isbergues) are promising and frequently studied SOFC/SOEC interconnect materials [1–5]. On thermal oxidation, these steels form protective, electrically conductive oxide scales comprised of Cr₂O₃ and (Mn,Cr)₃O₄ spinel [1,3,4,6–9].

A problem associated with chromium scales, however, is the formation of volatile chromium species like $CrO_2(OH)_2$ or CrO_3 at

elevated temperatures [10], which is significant for both Cr₂O₃ and (Mn,Cr)₃O₄ [6,11]. These gaseous chromium species have a tendency to undergo electrochemical reduction to Cr₂O₃ at gas/oxygen electrode/electrolyte three-phase boundaries or to chemically react with the oxygen electrode materials, thus leading to the poisoning of SOFC or SOEC oxygen electrodes [10,12–14]. To avoid performance degradation associated with chromium poisoning, steel interconnects are therefore often coated with protective layers [5,8,11,15,16].

In this study, we investigate the transport of chromium from steel interconnects into porous contact coatings and adjacent oxygen electrodes under severe SOE conditions in dry oxygen atmosphere at 700 °C for up to 3000 h. The $(La_{0.8}Sr_{0.2})(Mn_{0.5}Co_{0.5})O_{3-\delta}$ (LSMC) or La(Ni_{0.6}Fe_{0.4})O_{3- δ} (LNF) contact coatings are originally applied to the steel interconnect to minimize the ohmic resistance to the oxygen electrode in SOEC stacks, providing a homogeneous contact over the whole cell area. In addition, they may also trap chromium by chemical reactions, thus acting as protective layers. Furthermore, the effect of a dense (Co,Mn)₃O₄ spinel layer deposited between steel surface and contact coating is investigated. Such (Co,Mn)₃O₄ spinels bond well to stainless steel substrates under thermal cycling [2,17], feature a low electrical resistance [18], and have been shown to act as effective barriers to chromium outward migration [2,8,18,19]. We combine the microstructural evolution of contact layers and their interface to the steel interconnect after aging treatments representative of SOE anodic conditions with quantification of the chromium distribution in contact lavers and analysis of chromium transported into adjacent SOE anodes.

2. Experimental

Specimens were prepared by coating square $10 \times 10 \text{ mm}^2$ or $20 \times 20 \text{ mm}^2$ stainless steel pieces of Crofer 22 APU (ThyssenKrupp, Germany) and K41X (Aperam Isbergues, France) of 1 mm thickness with a contact layer. For this, slurries were prepared from powders of $(La_{0.8}Sr_{0.2})(Mn_{0.5}Co_{0.5})O_{3-\delta}$ (LSMC, Marion Technologies, France, $d_{50} = 0.33 \mu m$, $d_{90} = 0.45 \mu m$, specific surface area 13.6 m² g⁻¹) or La(Ni_{0.6}Fe_{0.4})O_{3- δ}(LNF, Marion Technologies, France, d₅₀ = 0.46 μ m, $d_{90} = 1.34 \,\mu\text{m}$, specific surface area 4.4 m² g⁻¹) and a 5 mass% solution of ethyl cellulose in terpineol. Four layers were deposited on top of each other by screen printing on both faces of the steel substrates with a 150 mesh screen (with drying steps of 15 min at 110 °C after each deposition to remove the solvent). For some samples - before deposition of the contact coatings - a $Co_{2-x}Mn_{1+x}$ metallic film was deposited on the steel substrates by magnetron sputtering (PVDco, France). This layer was then thermally oxidized into a 3-4 μm thick dense (Co,Mn)₃O₄ layer in air for 10 h at 800 °C.

Annealing was performed in a tube furnace (Carbolite, UK) under pure oxygen at a flow rate of 12 N ml min $^{-1}$ cm $^{-2}$ at heating and cooling rates of 5 °C min $^{-1}$. First, a pre-treatment was performed at 750 °C for 2 h to simulate the procedure in single repeat units and stacks associated with the formation of glass sealants. The samples were then annealed at 700 °C for 200 h or 3000 h. For

microstructural analyses of heat treated samples, polished cross sections were prepared after embedding in a mixture of Araldit BY 158 and Aradur 21 (Huntsman, USA) at a weight ratio of 4:1 by vacuum impregnation at 20 mbar and subsequent pressurization at 2 bars. A carbon coating was applied for scanning electron microscopy (SEM) and focused ion beam (FIB) applications. A Nova NanoSEM 230 microscope (FEI, USA) with Everhard-Thornley secondary electron (SE), solid state backscattered electron (BSE) and energy dispersive X-ray spectroscopy (EDS) detectors (X-Max, Oxford Instruments, UK) was used. EDS quantification was performed at 20 kV using a copper calibration standard and the software Inca (Oxford Instruments, UK). Lamellae for transmission electron microscopy (TEM) and scanning transmission electron microscopy (STEM) were prepared by FIB (Nova 200, FEI, USA). The surfaces of the samples were protected by carbon and platinum depositions and lamellae were prepared by cutting and polishing trenches into the samples with Ga+ ion beam currents down to 30 pA or 50 pA at 30 keV. Lift-outs of the lamellae to copper grids were performed using a manipulating probe (Omniprobe 100.7, Oxford Instruments, UK). For TEM analyses, a Tecnai F20 microscope (FEI, USA) was applied at 200 keV. Scanning transmission electron microscopy (STEM) images were collected using a highangle annular dark field detector (HAADF). Chemical composition maps were obtained using energy dispersive spectroscopy (EDS) and energy-filtered transmission electron microscopy (EFTEM).

For chromium evaporation measurements, a new method based on the trapping of volatile Cr species emitted by the interconnect samples in an adjacent electrode material was designed in this study. This approach differs from the quantitative transpiration method broadly used for such studies [20,21] with the aim to simultaneously test eight samples in one experiment. Bare or coated steel substrates of $20 \times 20 \text{ mm}^2$ (with a hole of 4 mm diameter, not required for evaporation testing but used for handling in case of oxidation testing) were placed into a custom-made quartz sample holder (see Fig. 1). On top of the steel substrates, commercial solid oxide cells (ESC2, H. C. Starck) $25 \times 25 \text{ mm}^2$ in size were placed with the $(La_{0.8}Sr_{0.2})MnO_{3-\delta}$ (LSM) electrodes facing the steel/coating surface at a distance of 0.5 µm. This distance was optimized to allow a reasonable Cr concentration in the electrode material after 500 h of testing while preventing a physical contact with the interconnect. After annealing at 700 °C in a static oxygen atmosphere for 500 h, the solid oxide cell samples were dissolved in an acidic solution and analyzed for Cr, La, Sr and Mn by inductively coupled plasma optical emission spectrometry (ICP-OES model 725, Agilent Technologies, USA). It should be noticed that the amount of Cr detected in LSM by this technique is linked to two phenomena: (i) Cr evaporation from interconnect materials, (ii) Cr trapping into LSM. For a given set of experiments carried out in identical conditions, i.e. in constant thermodynamical conditions, the Cr trapping into LSM may be inferred to only depend on the nature of the interconnect/coating combinations and on their subsequent Cr evaporation rate. Thus the technique does allow a screening of the interconnect materials on their ability to reduce Cr evaporation towards the oxygen electrode. However, since not all

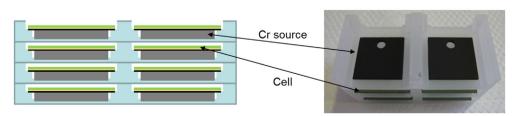


Fig. 1. Schematic and photograph of the quartz sample-holder for Cr evaporation testing.

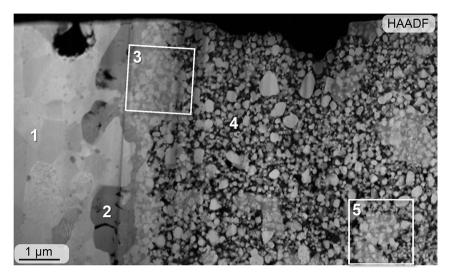


Fig. 2. HAADF-STEM overview of a Crofer/LSMC interface after annealing at 700 °C for 3000 h (FIB lamella). (1) Crofer 22 APU steel, (2) Cr₂MnO₄ spinel scale, (3) (Cr,Mn,Co)₃O₄ spinel around LSMC particles, (4) LSMC, (5) amorphous SrCrO₄ around former LSMC particles.

volatile species are trapped by the electrode material of the adjacent cell, a certain base level of Cr is found in all specimens. An absolute quantification of the transport of Cr species from the interconnect material, and consequently the determination of the Cr evaporation rate, are thus not possible.

3. Results and discussion

3.1. LSMC and LNF contact coatings on Crofer and K41X steels

On the surface of LSMC coated Crofer 22 APU, the formation of a Crrich scale of few hundred nanometers thickness is observed already after the initial heat treatment at 750 °C for 2 h according to BSE images and EDS linescans of polished cross sections (not shown here). With further annealing at 700 °C for 200 h and 3000 h, the thickness of this scale increases. In addition, an interfacial layer as well as reaction zones within the LSMC contact layer appear. The partially idiomorphic grains of up to 5 μ m diameter below the steel surface (e.g. position 2 in Fig. 2) are identified as cubic Cr2MnO4 spinel by electron diffraction. This is shown in more detail in the HAADF-STEM overview of a FIB section in Fig. 2, which depicts the Crofer/LSMC

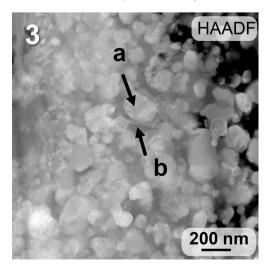


Fig. 3. HAADF-STEM image of position 3 in Fig. 2. EDS shows the presence of La, Sr, Mn, Co and O (LSMC) at location a, and of Co, Mn, Cr and O at location b ((Co,Mn,Cr) $_3$ O $_4$). Both phases are crystalline according to HR-TEM.

interface after annealing at 700 °C for 3000 h. Along the steel/LSMC interface, the pore space around the LSMC grains is filled up by a crystalline solid phase (see position 3, Fig. 2) within a layer of up to 1 μm thickness. This layer is composed of LSMC particles surrounded by a Cr–Mn–Co-oxide, probably a (Cr,Mn,Co)₃O₄ spinel (position b in Fig. 3). Crofer 22 APU, which contains 0.3–0.8% Mn [22], is known to form a scale layer composed of Cr₂MnO₄ spinel (due to Mn diffusion from the steel) and Cr_2O_3 [11,23]. As a result of Mn and Co diffusion from the contact coating, however, the Cr₂O₃ scale is replaced by a Cr-Mn-Co-oxide at the Crofer/LSMC interface in our study. The presence of this additional Mn source is also expected to further promote the development of the Cr₂MnO₄ spinel phase, similar to results reported for LSM [11] and (Mn,Co)₃O₄ [9] on Crofer 22 APU. While the interfacial reaction layer at the Crofer/LSMC interface may positively affect adhesion of the contact coatings to the steel surface, Cr₂MnO₄ and (Cr,Mn,Co)₃O₄ spinels feature rather low electrical conductivities in the order of 10^{-3} S cm⁻¹ and 10^{0} – 10^{1} S cm⁻¹ at 700 °C, respectively [24–26]. Increased thicknesses of the scale and interfacial layers due to diffusion of Co and Mn from the contact coating are thus expected to increase the contact resistance.

Features with a solid phase filling up the pore space around particles are also observed in defined areas within the LSMC layer (e.g. position 5 in Fig. 2). According to the EDS maps in Fig. 4 and HR-TEM (not shown here), this phase corresponds to a crystalline Sr-Cr-oxide, most likely SrCrO₄. The former LSMC particles in this area are depleted in Sr as compared to their original composition. These aggregates reach diameters of up to several micrometers and occur throughout the thickness of the coating, although they are larger within the first 15 µm of the LSMC layer (see Fig. 6a). The reaction of chromium from the steel interconnect to SrCrO₄ in the LSMC contact coating shows that mobile Cr species are transported through the whole coating even at a temperature of 700 °C after 3000 h. Besides compromising the electrical and ion conductivity of the Sr-depleted LSMC, these aggregates will negatively influence the gas transport properties of the contact coating. More importantly, LSMC is not able to effectively trap Cr over a longer period of time, so a poisoning of the adjacent oxygen electrode is expected. In solid oxide fuel cells, the formation of SrCrO₄ is known to increase the polarization and/or ohmic resistance of oxygen electrodes like LSM [14] or (La,Sr)(Co,Fe)O₃ (LSCF) [27] leading to a decrease in the voltage output in single-cell stacks [28].

Similar results as on Crofer are also obtained for LSMC contact coatings on K41X steel, which forms a crystalline Cr_2O_3 scale. The

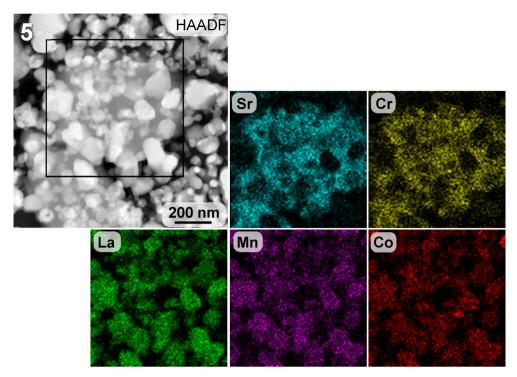


Fig. 4. HAADF-STEM image of position 5 in Fig. 2 and corresponding EDS maps of Sr, Cr, La, Mn, and Co.

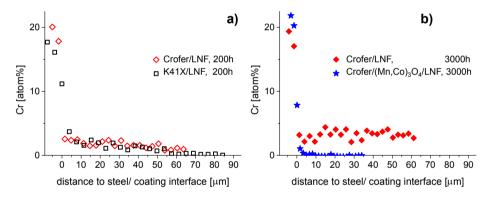


Fig. 5. Cr content detected by EDS linescans on polished sections of a) LNF contact coatings deposited directly on Crofer 22 APU or K41X steel substrates after annealing at 700 $^{\circ}$ C for 200 h, and b) LNF contact coatings deposited on Crofer 22 APU steel substrates with and without a (Mn,Co)₃O₄ coating after annealing at 700 $^{\circ}$ C for 3000 h.

presence of a $(Mn,Cr)_3O_4$ spinel scale was not detected for the given annealing conditions at 700 °C for up to 3000 h. At the K41X/LSMC interface, a $SrCrO_4$ -rich interfacial layer is observed on top of the Cr_2O_3 scale after the initial heat treatment at 750 °C for 2 h. Si is also

present at the interface. With further annealing at 700 $^{\circ}$ C, aggregates with SrCrO₄ surrounding former LSMC particles develop within the contact layer as described for LSMC on Crofer 22 APU. In contrast to Crofer 22 APU, however, delamination along the scale is

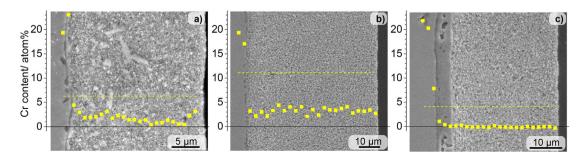


Fig. 6. Cr content detected by EDS linescans (along the dotted lines) on polished sections of a) LSMC, b) LNF and c) (Co,Mn) $_3$ O $_4$ /LNF contact coatings deposited on Crofer 22 APU steel substrates after annealing at 700 °C for 3000 h; overlay with backscattered electron images. The bright agglomerates in a) correspond to a SrCrO $_4$ phase surrounding former LSMC particles.

frequently observed for LSMC contact coatings on K41X after 3000 h of annealing.

In LNF contact coatings on Crofer 22 APU, interfacial layers (apart from the $\rm Cr_2MnO_4$ spinel scale), reaction zones or other obvious microstructural changes are not observed. This is also the case for LNF on K41X steel, although two oxide layers are detected at the interface to the steel on top of the $\rm Cr_2O_3$ scale after 3000 h at 700 °C in this sample, of which the bottom oxide layer contains Cr and Si, while La and Si are found in the top oxide layer. In addition, delamination along the scale is observed for LNF on K41X after 3000 h of annealing.

Despite the lack of microstructural indicators in LNF contact coatings, the presence of Cr is detected by EDS analyses in both LSMC and LNF layers on Crofer 22 APU as well as on K41X steels. The Cr content in LNF contact layers on Crofer 22 APU and K41X after 200 h of annealing is plotted in Fig. 5a as a function of distance to the steel/coating interface. While up to 3 atom% Cr are detected close to the interface, its content decreases towards the outer parts of the contact coating. For distances higher than 60 µm away from the steel surface, the Cr content is close to the detection limit. This indicates that the thickness of the contact coating is a key parameter to reduce the transport of chromium to the oxygen electrode in a given time frame. The distribution of Cr is very similar for both K41X and Crofer substrates, indicating that the formation of different scale layers on the steel surfaces of K41X and Crofer does not significantly influence the reaction of chromium species in the contact coating for an annealing time of 200 h. The lack of microstructural changes in LNF contact coatings suggests the incorporation of Cr into the LNF particles and the formation of Crcontaining perovskites, which can result in even more severe degradation of the area specific resistance (ASR) in LNF than in LSMC contact layers according to literature [23].

After 3000 h of annealing, the Cr content is similar throughout the thickness of the contact coatings (taking into account inhomogeneities, e.g. the formation of SrCrO₄-rich aggregates in the LSMC coatings, Fig. 6a). The presence of 2 ± 1 atom% Cr is detected in a $\approx 25~\mu m$ thick LSMC coating (Fig. 6a), while 3 ± 1 atom% Cr are detected in a $\approx 65~\mu m$ thick LNF coating on Crofer 22 APU (Fig. 6b). This could indicate a slightly more efficient mechanism of chromium trapping in LSMC as compared to LNF related to the formation of SrCrO₄. Furthermore, promotion of (Mn,Cr)₃O₄ and (Cr,Mn,Co)₃O₄ scale growth in the presence of (La_{0.8}Sr_{0.2})(Mn_{0.5}Co_{0.5})O_{3- δ} may influence the amount of volatile chromium species, as these spinels have been shown to exhibit lower partial pressures of mobile Cr-species as compared to pure Cr₂O₃ [6,11,21]. However, neither of these contact coatings is able prevent the transport of chromium over 3000 h under these conditions.

On K41X substrates, chromium is also present throughout the contact coatings. Due to delamination along the scale and interfacial reaction layers for both LSMC and LNF contact coatings on K41X after 3000 h of annealing, these values are not quantified.

The amount of chromium transported from steel samples (with or without contact coatings) into a SOE anode material (LSM) during annealing for 500 h at 700 °C in oxygen was also directly analyzed by the evaporation method described above.

The ratio of Cr/La measured in the LSM electrodes after annealing at 700 °C for 500 h in oxygen is presented in Fig. 7 for different combinations of interconnects and contact coatings, including bare steel substrates. Introduction of a contact coating significantly reduces the Cr content in the oxygen electrode as compared to the bare substrates. In general, slightly less Cr is detected for the K41X steel than for Crofer, which could reflect the lower Cr content of K41X as compared to Crofer (18 wt% vs. 22 wt%). Regarding the contact materials, less chromium is generally detected for LSMC than for LNF coatings in agreement with the

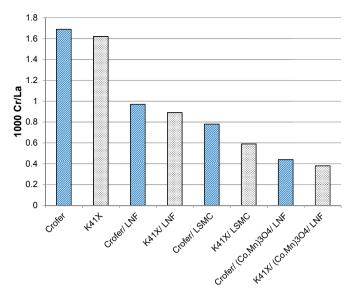


Fig. 7. Cr/La ratios measured by ICP-OES after 500 h at 700 $^{\circ}C$ in a LSM layer facing the different interconnect/coating combinations.

previous results obtained by EDS analyses. For longer annealing times, the transport of chromium into the SOE oxygen electrode is expected to be even more significant, given the increased chromium content in contact coatings after 3000 h (Fig. 6a and b).

3.2. Introduction of a dense (Co,Mn)₃O₄ spinel coating between steel and contact coating

To further inhibit the transport of chromium resulting in a performance degradation of contact coatings and electrodes, a (Co,Mn)₃O₄ spinel coating of 3–4 μm thickness was then added between steel and contact layer. An example is shown and discussed for Crofer 22 APU/(Co,Mn)₃O₄/LNF. According to the BSE image in Fig. 8 and the HAADF-STEM overview in Fig. 9, the PVD spinel coating forms a dense layer, although isolated pores are present along the steel/(Co,Mn)₃O₄ interface. On annealing at 700 °C for 3000 h, a Cr and O rich layer develops at this interface, in which some Mn is also present (EDS maps in Fig. 8). This crystalline scale layer has a thickness of up to 1 µm according to Fig. 9. The zero-loss and EFTEM images of Fe, Cr, Mn and Co in Fig. 10 give a more detailed view on the Crofer 22 APU/(Co,Mn)₃O₄ interface. According to the distribution of Cr and Mn, the interfacial scale layer seems to be composed of both Cr₂O₃ and Cr₂MnO₄ spinels as reported previously [8,9]. Furthermore, Cr is enriched at the surface of isolated pores at the steel/(Co,Mn)₃O₄ interface.

This $(Co,Mn)_3O_4$ coating effectively prevents the transport of Cr from the steel interconnect into the contact coatings, and Cr is not detected by EDS linescans through the LNF layer after annealing for 3000 h at 700 °C (see Figs. 5b and 6c). Also the evaporation method indicates a further reduction of Cr in the SOE oxygen electrode in the presence of the $(Co,Mn)_3O_4$ coating, which amounts to reductions of 74% and 78% on Crofer 22 APU and K41X steels as compared to bare Crofer steel, respectively (Fig. 7). Microstructural observations and chemical analyses of the K41X/ $(Co,Mn)_3O_4/LNF$ combination are not shown because of delamination at the steel/oxide interface.

In view of application in SOE stacks, the aging behavior of the interconnect/coating combination is of high importance. This includes not only the capacity to trap chromium, but also the adherence of coatings and the overall area specific resistance. For this, not only the properties of the coating materials but also those of the

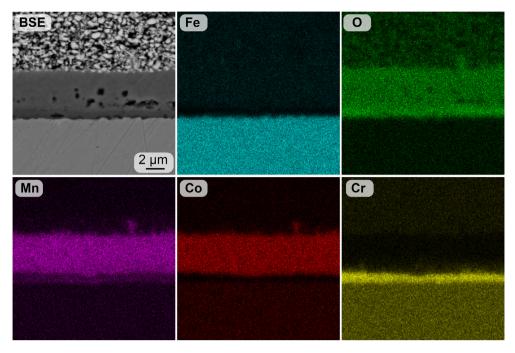


Fig. 8. BSE image and EDS maps (Fe, O, Mn, Co and Cr) of the Crofer/(Mn,Co)₃O₄/LNF interfaces after annealing at 700 °C for 3000 h (polished cross section).

reaction products formed during operation have to be taken into account. In literature [2], a loss of adherence has been reported between $(La_{0.8}Sr_{0.2})(Co_{0.75}Fe_{0.25})O_{3-\delta}$ (LSCF) contact layers and Co_{1.9}Fe_{0.1}MnO₄ on Crofer due to an insufficient match of the corresponding thermal expansion coefficients (see Table 1). For MnCo₂O₄, an even lower TEC of $9.7 \cdot 10^{-6}$ K⁻¹ has been published [25], while values of $11.1 \cdot 10^{-6} \text{ K}^{-1}$ and $13.2 \cdot 10^{-6} \text{ K}^{-1}$ for LNF [29,30] and $13.7 \cdot 10^{-6} \,\mathrm{K}^{-1}$ for LSMC [31] are found. Nevertheless, the (Co,Mn)₃O₄ coatings in this study show good adherence to the Crofer 22 APU substrate also after annealing at 700 °C for 3000 h in oxygen according to the SEM and FIB sections. In contrast, delamination was more frequently observed along and within the (Co,Mn)₃O₄ protective layer as well as along LSMC and LNF contact coatings on K41X steel. The observed delaminations seem to have occurred upon cooling since no correlation has been observed with the results on chromium transport by the evaporation method. As the TECs of the two steels are quite similar (see Table 1), the formation of reaction products at the interface could be responsible for delamination.

4. Conclusions

Even under simulated SOE operating conditions at a relatively mild temperature of 700 °C without current and in the absence of water vapor on the anode side, chromium transport from steel interconnects into contact coatings is significant. The formation of different scale layers on the surface of K41X (mainly Cr₂O₃) and Crofer 22 APU (mainly Cr₂MnO₄) does not significantly influence the transport of chromium, leading to very similar Cr distributions in the LNF contact layer after 200 h of annealing, probably in the form of perovskites. In the case of the LSMC coatings, an additional reaction layer with a (Cr,Mn,Co)₃O₄ spinel phase surrounding the LSMC particles is formed at the interface, and aggregates with SrCrO₄ filling up the pores space around former LSMC particles develop throughout the LSMC layer. These chemical reactions negatively influence the ionic and electronic conductivity of the contact materials (as well as their gas diffusion properties in terms of aggregates). Furthermore, the trapping of chromium species in

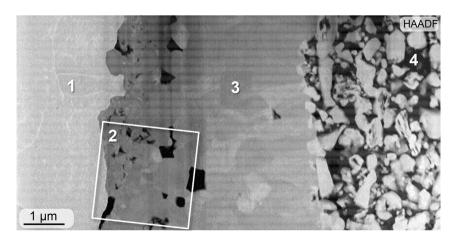


Fig. 9. HAADF-STEM overview of the Crofer/(Mn,Co) $_3$ O₄/LNF interfaces after annealing at 700 °C for 3000 h (FIB lamella). (1) Crofer 22 APU steel, (2) Cr $_2$ MnO $_4$ /Cr $_2$ O $_3$ scale, (3) (Mn,Co) $_3$ O $_4$ spinel coating, (4) LNF.

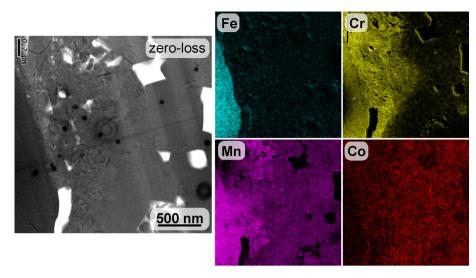


Fig. 10. Zero-loss image of Crofer/(Mn,Co)₃O₄ interface (position 2 in Fig. 9) and corresponding EFTEM maps of Fe, Cr, Mn and Co.

Table 1Thermal expansion coefficients (TECs) of steels and coatings reported in literature.

Material	TEC [10 ⁻⁶ K ⁻¹]
Crofer 22 APU	11.9 (20-800 °C) [22]
K41X	12.8 (20-800 °C) [32]
$Co_{1.9}Fe_{0.1}MnO_4$	13.4 (30–800 °C) [2] and Refs. therein
Co ₂ MnO ₄	9.7 (20-800 °C) [25]
LSCF	19 (30–800 °C) [2] and Refs. therein
LSMC	13.7 (100-900 °C) [31]
LNF	11.1 (30-800 °C) [29], 13.2 (30-1000 °C) [30]

the porous contact layers by chemical reactions does not prevent the transport of chromium into adjacent electrodes for more than a few hundred hours at 700 °C, and further transport is expected with time. This shows that the application of chromium diffusion barriers on steel interconnects is essential also for operation at 700 °C in dry oxygen. The introduction of a dense (Co,Mn)₃O₄ protective layer is able to reduce the amount of chromium in a SOE oxygen electrode by more than 70% after 500 h at 700 °C according to an evaporation study, and chromium is not detected in the contact layer even after 3000 h. The (Co,Mn)₃O₄ protective layer should thus avoid the poisoning of anode and contact coatings, leading to extended stack performance and lifetime.

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